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High gain single GaAs nanowire photodetector

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An undoped single GaAs nanowire (NW) photodetector based on a metal–semiconductor–metal Schottky diode structure is fabricated by a focused ion beam method. The photoconductive gain of the device reaches 20,000 at low laser excitation. Bias-dependence of gain proves that the surface contributes more to the gain at higher bias because of an increased surface charge region. The spectral response demonstrates not only the band-edge absorption profile of the single GaAs NW, but also the existence of leaky-mode resonance.

Metal–semiconductor–metal (M-S-M) structures have been employed to fabricate devices such as InGaAs photodetectors (PDs) for several decades. In such devices, a Schottky barrier forms at the metal/semiconductor interface and plays a crucial role in device performance. PDs based on the one-dimensional nanowire (NW) Schottky diode structure are of great interest because of the NWs size and associated physical properties. In NW PDs, Schottky barrier height is very sensitive to carrier generation and transport, and so controls the sensitivity of the PDs. Such PDs also show many advantages, for example, CdSe nanobelt PDs can be operated at high speed and photosensitivity. ZnS PDs have the greatest potential as a UV detector within the UV-A band, and ZnO NW PDs have extremely high internal gain which results in a high gain-bandwidth product. Such superiorsities are attributed to the high surface-to-volume ratio of the NWs (contributing to their high photosensitivity) and the reduced dimensions of the effective conductive channel (producing both high speed and high gain).

Here, we report the fabrication and optoelectronic properties of an undoped single GaAs NW PD using the focused ion beam (FIB) technique and based on the back-to-back contact structure with Pt as the metal. Photoconductive gain up to 20,000 with no observed saturation is achieved at 522 nm laser excitation. Both the band-edge absorption profile of the GaAs NW and their leaky-mode resonance are demonstrated and confirmed by simulation. The bias-dependences of gain and spectral response indicate that the surface plays a greater role in carrier transportation at higher bias.

Horizontal flow MOCVD was employed to grow undoped NWs at a pressure of 100 mbar and a total gas flow rate of 15 slm using the two-temperature growth process. The NWs were grown on semi-insulating GaAs (111)B substrates using trimethylgallium (TMG) and arsine (AsH3) precursors with 100 nm diameter Au nanoparticles as the catalyst. The obtained NWs had heights between 15 and 20 μm, diameters of 90–160 nm, and a V/III ratio of 46. After growth the NWs were separated from the substrate in an isopropanol solution by ultrasonication and then transferred on a photolithographically patterned Au-coated sapphire substrate. Pt was deposited on each end of a NW using a FIB system (FEI Helios 600 Nanolab) at 28 pA/30 kV to form Schottky contacts which were then connected to the Au electrodes. Current-voltage (IV) measurements were performed with a semiconductor parameter analyzer (HP4140). A pulsed laser operating at 1044 nm and frequency doubled to 522 nm with a pulse duration of 300 fs and a repetition rate of 20 MHz was used to photoexcite the device. After I-V measurements with laser injection, the laser beam was mechanically chopped at 280 Hz to induce a photocurrent with a digital lock-in amplifier. This setup was also used to characterize the polarization response by applying a 2.0 V bias across the NW. A xenon lamp (1000 W) with a digital lock-in amplifier was used as a continuous wavelength light source for light absorption measurements. The data from the lock-in amplifier and monochromator were collected with a computer and processed.

Fig. 1 shows an image of the device and its photocurrent mapping. The NW shown had a length of 16.1 μm and diameter of 160 nm. The 2 μm tail of the FIB deposition beam could also be clearly observed (Fig. 1(a)), which means that the greatest part of the device was not contaminated during the process. The photocurrent mapping (Fig. 1(b)) exhibits large photocurrents at the contacts, which was due to diffusion-limited carrier transportation and local band-bending at the contact interfaces under bias (inset of Fig. 1(b)).

Fig. 2(a) shows I-V curve of the device under laser excitation. The current increases with bias voltage with a bending characteristic in the voltage range of −1 V to 1 V, attributed to the back-to-back M-S-M Schottky diode structure. It also reveals that photogenerated holes/electrons increased its conductivity under laser excitation due to photogating and photodoping effects. Fig. 2(a) also gives the corresponding photocurrent curves, which increase sharply in the −1 V to +1 V range and then reach saturation. This is because sufficient bias must be applied to obtain a flat band at the anode and separate the generated carriers.

Fig. 2(b) displays photocurrent vs. absorbed excited laser power intensity. Considering the order of magnitude absorption difference between the absorption at 840 nm (1.48 eV) and that at 522 nm (2.37 eV) from Fig. 3(a) and the 30% reflectance of the GaAs surface at 840 nm, the absorbance at 522 nm was estimated to be 7%. Fig. 2(b) shows that the photocurrent increased exponentially with laser power,
while obeying the power law dependence \( I \sim P^a \), where \( a \) is 0.64, 0.55, and 0.52 for the biases of 2 V, 3 V, and 4 V, respectively. It is concluded that this decrease of \( a \) was due to the effect of defects on carrier transportation, namely that higher bias caused more defects to become involved in carrier transportation. Further discussion on the contribution of surface defects is given below.

The photoconductive gain of the device under 522 nm laser excitation (Fig. 2(d)) reached 20\,000 at an absorption of 0.3 W/cm\(^2\) and without saturation. The gain could be expected to be even higher at even lower laser excitation because the gain of ZnO NWs has been reported to reach \( 10^9 \) when excited by a relatively low light power of 10 \( \mu \)W/cm\(^2\). Because of the high surface-to-volume ratio of a NW, electrons or holes are trapped and this results in accumulation of the corresponding holes or electrons. In this experiment, light excited electrons moved to the surface of the undoped GaAs nanowire and were trapped, causing the accumulation of light excited holes. Thus, both of the electron trapping on the NW surface and the hole accumulation would affect the carrier drift and are the origin of the high gain observed. And since the absorption coefficient for extrinsic photoconductor is much lower than for intrinsic, it can be expected the gain would drop once the employed NW was intentionally doped. The gain observed in this work was also related to the excited laser intensity, and followed an inverse power law: \( g \sim P^{-k} \). Here, \( k \) is 0.65, 0.72, and 0.89 for biases of 2 V, 3 V, and 4 V, respectively. This increase of \( k \) with bias indicates that surface defects contributed more to carrier transportation; a \( k \) value close to 0.9 for the NW confirms that gain was dominated by the surface. Under higher bias the space charge region (SCR) becomes thicker, which decreases the effective cross-sectional area of carrier transportation paths through NW bulk section. In addition, the increased bias caused more electrons to be generated in NW bulk section and trapped on the surface, which increased the surface carrier density. Both of these effects, decrease of carrier transportation path and increase of surface carrier density, enhance the role of the surface in carrier transportation with bias increase. Thus, the greater contribution of the surface to the gain under higher bias is the reason for the observed \( k \) increase. In addition, the gain at 0.07 W/cm\(^2\) increased from 10\,000 to 20\,000 when the bias was increased from 2 V to 4 V. The increase of both \( k \) and gain confirm that the surface has a greater effect on gain under higher bias. It can be expected the \( k \) value would be lower if the NW is doped, since its SCR would be thinner compared with undoped NW.
Fig. 3(a) plots the spectral response of the single NW device and shows two distinct peaks for the region investigated. The most sensitive peak at 1.5 eV exhibited blue shift as well as increased absorption with bias. Such a blue shift could be attributed to the band-edge absorption of the GaAs NW. The signal increase was caused by the involvement of more carriers in the gain response due to the increase of carrier transportation rate with bias. In combination with the gain behavior observed under bias, it can therefore be concluded that under higher bias, the greater the amount of electron-hole pairs generated, the more the surface contributes to gain. The increased accumulation of carriers in the conduction and valence bands at higher bias caused the quasi-Fermi levels in the respective bands to move towards higher energy, resulting in the observed absorption peak blue shift.

The numerical simulations were performed for the peak in the 2.0 eV to 2.5 eV range using the finite-difference-time-domain (FDTD) technique with Lumerical FDTD Solutions. The resulting two-dimensional simulations modeled the GaAs NW as an ideal dielectric cylinder of infinite length, with complex refractive index (source Palik). A 160 nm diameter was used corresponding to the diameter of the NW in the fabricated device. The power absorbed (W/m) by the NW was determined under plane wave excitation for both transverse-electric (TE) (E vector perpendicular to NW axis) and transverse-magnetic (TM) (E vector parallel to NW axis) polarization, and in the range from 1.4 eV to 2.75 eV. The total power absorbed divided by the source intensity (W/m²) gives the absorption cross-section (m). The field profiles across the cross-section of the NW were also obtained from the same simulations.

The results of the numerical simulations are shown in Fig. 3(b), where both TE and TM spectra exhibit another peak at higher energy level (2.3 eV). In Fig. 3(c), the configuration of the power intensity for TE and TM modes of the respective energy levels clearly demonstrates that the electric field intensity for the resonance at 2.3 eV was 2 times or even higher than that at 1.9 eV and at 2.6 eV, for TE and TM modes, confirming that 550 nm (2.3 eV) is a leaky-mode resonant wavelength for GaAs NWs with a diameter of 160 nm. The variation of the peak intensity at 2.3 eV for the measured and simulated results is due to the discrepancy between the real NW geometry and the ideal design.

Fig. 4. Photocurrent polarization response under 2 V bias and 522 nm laser excitation with a power of 25 mW cm⁻².
Polarized photodetection of the single GaAs NW was also performed, and the results are given in Fig. 4. The dependence of the photocurrent signal on the polarization of the exciting light shows that the NW geometry strongly affected the polarization of emitted or absorbed photons and indicates that an individual NW is a suitable device element.

In summary, a M-S-M Schottky PD based on a single GaAs NW was fabricated using FIB and its optoelectronic properties were characterized. The surface exhibited photoconductive gain and greater spectral absorption under higher bias. At low laser excitation, a photoconductive gain of 20 000 was achieved. The band-edge absorption profile and leaky-mode resonance of the GaAs NW was explored in detail. The present work paves a way to the fabrication of highly sensitive detectors based on single GaAs NWs.

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